

Zener Voltage Regulators

MMSZ4xxxT1G Series, SZMMSZ4xxxT1G Series

500 mW, Low I_{ZT} SOD-123 Surface Mount



SOD-123
CASE 425
STYLE 1

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD-123 package. These devices provide a convenient alternative to the leadless 34-package style.

Features

- 500 mW Rating on FR-4 or FR-5 Board
- Wide Zener Reverse Voltage Range – 1.8 V to 43 V
- Low Reverse Current (I_{ZT}) – 50 μA
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant*

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

POLARITY: Cathode indicated by polarity band

FLAMMABILITY RATING: UL 94 V-0

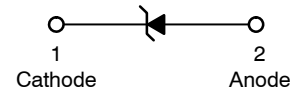
MAXIMUM RATINGS

| Rating | Symbol | Max | Units |
|--|-----------------------------------|----------------|-------------|
| Total Power Dissipation on FR-5 Board, (Note 1) @ T _L = 75°C Derated above 75°C | P _D | 500 6.7 | mW mW/°C |
| Thermal Resistance, (Note 2) Junction-to-Ambient | R _{θJA} | 340 | °C/W |
| Thermal Resistance, (Note 2) Junction-to-Lead | R _{θJL} | 150 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 = 3.5 X 1.5 inches, using the minimum recommended footprint.
2. Thermal Resistance measurement obtained via infrared Scan Method.

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



MARKING DIAGRAM



xx = Device Code (Refer to page 3)

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|---------------|----------------------|-------------------------|
| MMSZ4xxxT1G | SOD-123 (Pb-Free) | 3,000 / Tape & Reel |
| SZMMSZ4xxxT1G | SOD-123 (Pb-Free) | 3,000 / Tape & Reel |
| MMSZ4xxxT3G | SOD-123 (Pb-Free) | 10,000 / Tape & Reel |
| SZMMSZ4xxxT3G | SOD-123 (Pb-Free) | 10,000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DEVICE MARKING INFORMATION

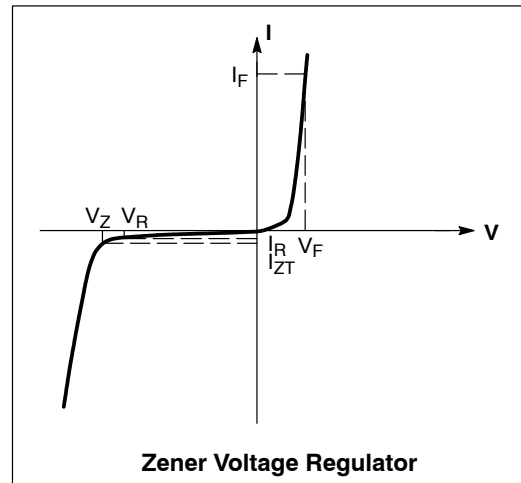
See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

MMSZ4xxxT1G Series, SZMMSZ4xxxT1G Series

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.9\text{ V Max. @ } I_F = 10\text{ mA}$)

| Symbol | Parameter |
|----------|----------------------------------|
| V_Z | Reverse Zener Voltage @ I_{ZT} |
| I_{ZT} | Reverse Current |
| I_R | Reverse Leakage Current @ V_R |
| V_R | Reverse Voltage |
| I_F | Forward Current |
| V_F | Forward Voltage @ I_F |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



MMSZ4xxxT1G Series, SZMMSZ4xxxT1G Series

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.9\text{ V Max.}$ @ $I_F = 10\text{ mA}$)

| Device* | Device Marking | Zener Voltage (Note 3) | | | | Leakage Current | |
|-----------------|----------------|------------------------|-----|-------|---------------|-----------------|-------|
| | | V_Z (Volts) | | | @ I_{ZT} | I_R @ V_R | |
| | | Min | Nom | Max | μA | μA | Volts |
| MMSZ4678T1G | CC | 1.71 | 1.8 | 1.89 | 50 | 7.5 | 1 |
| MMSZ4679T1G | CD | 1.90 | 2.0 | 2.10 | 50 | 5 | 1 |
| MMSZ4680T1G | CE | 2.09 | 2.2 | 2.31 | 50 | 4 | 1 |
| MMSZ4681T1G | CF | 2.28 | 2.4 | 2.52 | 50 | 2 | 1 |
| MMSZ4682T1G | CH | 2.565 | 2.7 | 2.835 | 50 | 1 | 1 |
| MMSZ4683T1G | CJ | 2.85 | 3.0 | 3.15 | 50 | 0.8 | 1 |
| MMSZ4684T1G | CK | 3.13 | 3.3 | 3.47 | 50 | 7.5 | 1.5 |
| MMSZ4685T1G | CM | 3.42 | 3.6 | 3.78 | 50 | 7.5 | 2 |
| MMSZ4686T1G | CN | 3.70 | 3.9 | 4.10 | 50 | 5 | 2 |
| MMSZ4687T1G | CP | 4.09 | 4.3 | 4.52 | 50 | 4 | 2 |
| SZMMSZ4687T1G | CG6 | 4.09 | 4.3 | 4.52 | 50 | 4 | 2 |
| MMSZ4688T1G | CT | 4.47 | 4.7 | 4.94 | 50 | 10 | 3 |
| MMSZ4689T1G | CU | 4.85 | 5.1 | 5.36 | 50 | 10 | 3 |
| MMSZ4690T1G/T3G | CV | 5.32 | 5.6 | 5.88 | 50 | 10 | 4 |
| MMSZ4691T1G | CA | 5.89 | 6.2 | 6.51 | 50 | 10 | 5 |
| MMSZ4692T1G | CX | 6.46 | 6.8 | 7.14 | 50 | 10 | 5.1 |
| MMSZ4693T1G | CY | 7.13 | 7.5 | 7.88 | 50 | 10 | 5.7 |
| MMSZ4694T1G | CZ | 7.79 | 8.2 | 8.61 | 50 | 1 | 6.2 |
| MMSZ4695T1G | DC | 8.27 | 8.7 | 9.14 | 50 | 1 | 6.6 |
| MMSZ4696T1G | DD | 8.65 | 9.1 | 9.56 | 50 | 1 | 6.9 |
| MMSZ4697T1G | DE | 9.50 | 10 | 10.50 | 50 | 1 | 7.6 |
| MMSZ4698T1G | DF | 10.45 | 11 | 11.55 | 50 | 0.05 | 8.4 |
| MMSZ4699T1G | DH | 11.40 | 12 | 12.60 | 50 | 0.05 | 9.1 |
| MMSZ4700T1G | DJ | 12.35 | 13 | 13.65 | 50 | 0.05 | 9.8 |
| MMSZ4701T1G | DK | 13.30 | 14 | 14.70 | 50 | 0.05 | 10.6 |
| MMSZ4702T1G | DM | 14.25 | 15 | 15.75 | 50 | 0.05 | 11.4 |
| MMSZ4703T1G † | DN | 15.20 | 16 | 16.80 | 50 | 0.05 | 12.1 |
| MMSZ4704T1G | DP | 16.15 | 17 | 17.85 | 50 | 0.05 | 12.9 |
| MMSZ4705T1G | DT | 17.10 | 18 | 18.90 | 50 | 0.05 | 13.6 |
| MMSZ4706T1G | DU | 18.05 | 19 | 19.95 | 50 | 0.05 | 14.4 |
| MMSZ4707T1G | DV | 19.00 | 20 | 21.00 | 50 | 0.01 | 15.2 |
| MMSZ4708T1G | DA | 20.90 | 22 | 23.10 | 50 | 0.01 | 16.7 |
| MMSZ4709T1G | DX | 22.80 | 24 | 25.20 | 50 | 0.01 | 18.2 |
| MMSZ4710T1G | DY | 23.75 | 25 | 26.25 | 50 | 0.01 | 19.0 |
| MMSZ4711T1G † | EA | 25.65 | 27 | 28.35 | 50 | 0.01 | 20.4 |
| MMSZ4712T1G | EC | 26.60 | 28 | 29.40 | 50 | 0.01 | 21.2 |
| MMSZ4713T1G | ED | 28.50 | 30 | 31.50 | 50 | 0.01 | 22.8 |
| MMSZ4714T1G | EE | 31.35 | 33 | 34.65 | 50 | 0.01 | 25.0 |
| MMSZ4715T1G | EF | 34.20 | 36 | 37.80 | 50 | 0.01 | 27.3 |
| MMSZ4716T1G | EH | 37.05 | 39 | 40.95 | 50 | 0.01 | 29.6 |
| MMSZ4717T1G | EJ | 40.85 | 43 | 45.15 | 50 | 0.01 | 32.6 |

3. Nominal Zener voltage is measured with the device junction in thermal equilibrium at $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$.

*Include SZ-prefix devices where applicable.

†MMSZ4703 and MMSZ4711 Not Available in 10,000/Tape & Reel

TYPICAL CHARACTERISTICS

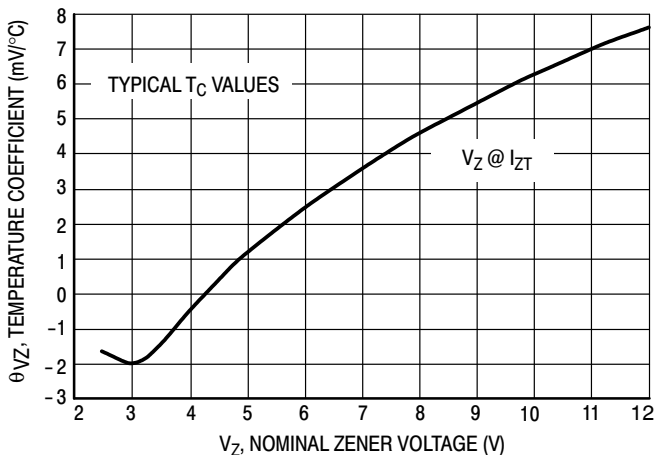


Figure 1. Temperature Coefficients (Temperature Range -55°C to +150°C)

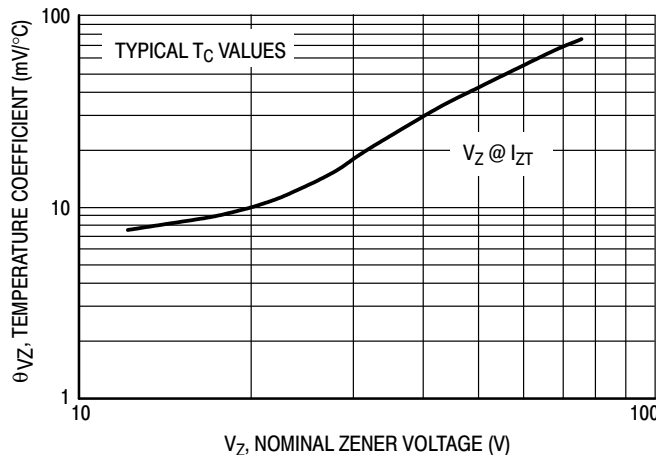


Figure 2. Temperature Coefficients (Temperature Range -55°C to +150°C)

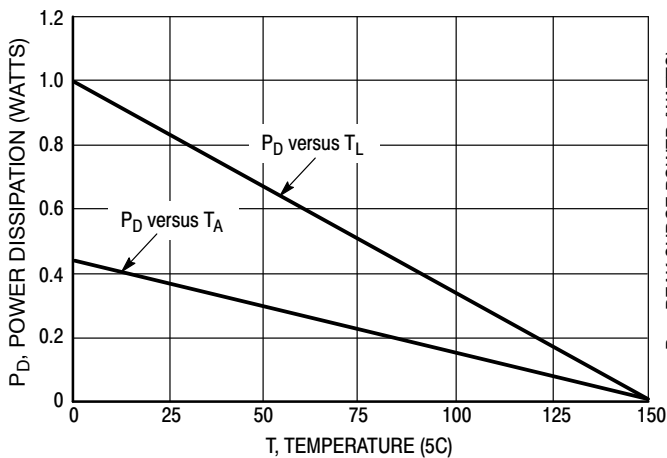


Figure 3. Steady State Power Derating

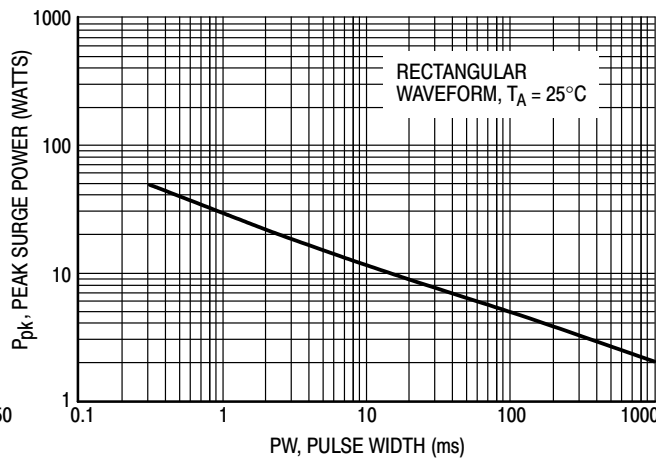


Figure 4. Maximum Nonrepetitive Surge Power



Figure 5. Effect of Zener Voltage on Zener Impedance

TYPICAL CHARACTERISTICS



Figure 6. Typical Capacitance



Figure 7. Typical Leakage Current



Figure 8. Zener Voltage versus Zener Current
(V_Z Up to 12 V)



Figure 9. Zener Voltage versus Zener Current
(12 V to 91 V)

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®



SCALE 5:1

SOD-123
CASE 425-04
ISSUE G

DATE 07 OCT 2009



- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: INCH.

| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.94 | 1.17 | 1.35 | 0.037 | 0.046 | 0.053 |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 |
| c | --- | --- | 0.15 | --- | --- | 0.006 |
| D | 1.40 | 1.60 | 1.80 | 0.055 | 0.063 | 0.071 |
| E | 2.54 | 2.69 | 2.84 | 0.100 | 0.106 | 0.112 |
| HE | 3.56 | 3.68 | 3.86 | 0.140 | 0.145 | 0.152 |
| L | 0.25 | --- | --- | 0.010 | --- | --- |
| θ | 0° | --- | 10° | 0° | --- | 10° |

GENERIC MARKING DIAGRAM*



- XXX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

STYLE 1:
PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 (mm / inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| | | |
|------------------|-------------|--|
| DOCUMENT NUMBER: | 98ASB42927B | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| DESCRIPTION: | SOD-123 | PAGE 1 OF 1 |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support:

Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative